



Pixus Technologies Statement Regarding the Dodd-Frank Act: US Conflict Minerals Law

Waterloo, Ontario, November 12, 2014 – Pixus Technologies, a supplier of electronic packaging systems and components and the exclusive North American supplier of Rittal products, is familiar with the US Conflict Minerals Law and is assisting with U.S. customers’ efforts to comply with their obligations under the law. As such, we review the products being supplied to those customers to determine if they contain materials that are otherwise referred to as “Covered Minerals”. If we believe the product may contain Covered Minerals we use our best efforts to confirm their use and establish the supplier’s understanding and efforts to comply with the initiative.

We direct our U.S. customers purchasing Rittal products through Pixus Technologies to the Conflict Minerals statement released by Rittal, entitled “[Statement Dodd-Frank Act: US Conflict Minerals Law / EU-Initiative](#)”. In this statement, Rittal addresses the very products being supplied by Pixus with the statement, “We use no Covered Minerals for any of the Rittal mechanical products, such as enclosures, racks, mechanical parts, metal sheets, and assembly rails.”

Therefore, as it pertains to Rittal products being supplied to our U.S. customers, the US Conflict Minerals Law and the corresponding EU initiative does not apply.

Jacques Houde, President
Pixus Technologies

About Pixus Technologies

Leveraging over 20 years of innovative standard products, the Pixus team is comprised of industry experts in electronics packaging. Founded in 2009 by Senior Management from Kaparel Corporation, a Rittal company, Pixus Technologies' embedded backplanes and systems are focused primarily on xTCA, OpenVPX, PCIe and custom designs. Pixus also has an extensive library of VME and cPCI based solutions. In May 2011, Pixus Technologies became the exclusive North and South American supplier of the electronic packaging products previously offered by Kaparel Corporation and Rittal.

Pixus Technologies is actively involved in the continuous development of leading xTCA, OpenVPX, and cPCI/PCIe products that will surpass all data transfer and cooling challenges.